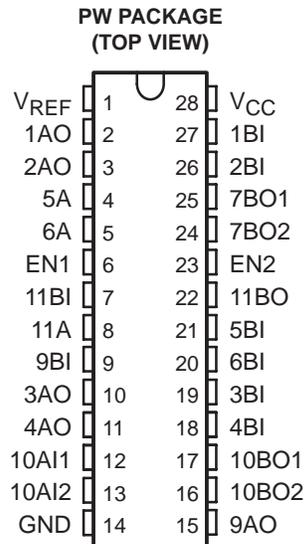


- Operates as a GTL-/GTL/GTL+ to LVTTTL or LVTTTL to GTL-/GTL/GTL+ Translator
- Series Termination on TTL Outputs of 30  $\Omega$
- Latch-Up Testing Done to JEDEC Standard JESD 78
- ESD Performance Tested Per JESD 22
  - 2000-V Human-Body Model (A114-B, Class II)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)



### description/ordering information

The SN74GTL2007 is a 12-bit translator to interface between the 3.3-V LVTTTL chip set I/O and the Xeon™ processor GTL-/GTL/GTL+ I/O. The device is designed for platform health management in dual-processor applications.

### PIN DESCRIPTION

| PIN NUMBER             | SYMBOL                             | NAME AND FUNCTION                       |
|------------------------|------------------------------------|---|
| 1                      | V <sub>REF</sub>                   | GTL reference voltage                   |
| 2-6, 8, 10-13, 15, 23  | EN <sub>n</sub><br>nA <sub>n</sub> | Data and enable inputs/outputs (LVTTTL) |
| 7, 9, 16, 17-22, 24-27 | nB <sub>n</sub>                    | Data inputs/outputs (GTL-/GTL/GTL+)     |
| 14                     | GND                                | Ground (0 V)                            |
| 28                     | V <sub>CC</sub>                    | Positive supply voltage                 |

### ORDERING INFORMATION

| T <sub>A</sub> | PACKAGE†   | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|------------|-----------------------|------------------|
| -40°C to 85°C  | TSSOP – PW | Tube                  | GK2007           |
|                |            | Tape and reel         |                  |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.

**PRODUCTION DATA** information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2005, Texas Instruments Incorporated

# SN74GTL2007

## 12-BIT GTL-/GTL/GTL+ TO LVTTL TRANSLATOR

SCLS609 – MARCH 2005

### Function Tables

| INPUTS |         | OUTPUT<br>1AO/2AO |
|--------|---------|-------------------|
| EN1    | 1BI/2BI |                   |
| H      | L       | L                 |
| H      | H       | H                 |
| L      | X       | H                 |

| INPUTS |         | OUTPUT<br>3AO/4AO |
|--------|---------|-------------------|
| EN2    | 3BI/4BI |                   |
| H      | L       | L                 |
| H      | H       | H                 |
| L      | X       | H                 |

| INPUT<br>9BI | OUTPUT<br>9AO |
|--------------|---------------|
| L            | L             |
| H            | H             |

| INPUTS      |     | OUTPUT<br>10BO1/10BO2 |
|-------------|-----|-----------------------|
| 10AI1/10AI2 | 9BI |                       |
| L           | L   | L                     |
| L           | H   | L                     |
| H           | L   | L                     |
| H           | H   | H                     |

| INPUTS |         | INPUT/OUTPUT<br>5A/6A<br>(OPEN DRAIN) | OUTPUT<br>7BO1/7BO2 |
|--------|---------|---------------------------------------|---------------------|
| EN2    | 5BI/6BI |                                       |                     |
| H      | L       | L                                     | H <sup>†</sup>      |
| H      | H       | L <sup>‡</sup>                        | L                   |
| H      | H       | H                                     | H                   |
| L      | H       | L <sup>‡</sup>                        | L                   |
| L      | H       | H                                     | H                   |
| L      | L       | H                                     | H                   |
| L      | L       | L <sup>‡</sup>                        | H                   |

| INPUT<br>11BI | INPUT/OUTPUT<br>11A<br>(OPEN DRAIN) | OUTPUT<br>11BO |
|---------------|-------------------------------------|----------------|
| L             | H                                   | L              |
| L             | L <sup>‡</sup>                      | H              |
| H             | L                                   | H              |

H = High voltage level

L = Low voltage level

<sup>†</sup> The enable on 7BO1/7BO2 includes a delay that prevents a transient condition (where 5BI/6BI goes from low to high, and the low to high on 5A/6A lags up to 100 ns) from causing a low glitch on the 7BO1/7BO2 outputs.

<sup>‡</sup> Open-drain input/output terminal is driven to a logic-low state by an external driver.





# SN74GTL2007

## 12-BIT GTL-/GTL/GTL+ TO LVTTTL TRANSLATOR

SCLS609 – MARCH 2005

### absolute maximum ratings over operating free-air temperature (unless otherwise noted)†‡

|   |               |
|---|---------------|
| Supply voltage range, $V_{CC}$  | –0.5 to 4.6 V |
| Input voltage range, $V_I$ (see Note 2): A port (LVTTTL)                      | –0.5 to 4.6 V |
| B port (GTL)  | –0.5 to 4.6 V |
| Output voltage range, $V_O$ (output in OFF or HIGH state)(see Note 2): A port | –0.5 to 4.6 V |
| B port  | –0.5 to 4.6 V |
| Input diode current, $I_{IK}$ ( $V_I < 0$ )                                   | –50 mA        |
| Output diode current, $I_{OK}$ ( $V_O < 0$ )                                  | –50 mA        |
| Current into any output in the LOW state: A port                              | 32 mA         |
| B port  | 30 mA         |
| Current into any output in the HIGH state, A port                             | –32 mA        |
| Package thermal impedance, $\theta_{JA}$ (see Note 1)                         | 62°C/W        |
| Storage temperature range, $T_{stg}$  | –60 to 150°C  |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

‡ Voltages are referenced to GND (ground = 0 V).

- NOTES: 1. The performance capability of a high-performance integrated circuit, in conjunction with its thermal environment, can create junction temperatures that are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
2. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

### recommended operating conditions

|           |                                      | MIN               | NOM      | MAX               | UNIT |   |
|-----------|--------------------------------------|-------------------|----------|-------------------|------|---|
| $V_{CC}$  | Supply voltage                       | 3                 | 3.3      | 3.6               | V    |   |
| $V_{TT}$  | Termination voltage                  | GTL–              | 0.85     | 0.9               | 0.95 | V |
|           | GTL                                  | 1.14              | 1.2      | 1.26              |      |   |
|           | GTL+                                 | 1.35              | 1.5      | 1.65              |      |   |
| $V_{REF}$ | Reference voltage                    | Overall           | 0.5      | $2/3 V_{TT}$      | 1.8  | V |
|           | GTL–                                 | 0.5               | 0.6      | 0.63              |      |   |
|           | GTL                                  | 0.76              | 0.8      | 0.84              |      |   |
|           | GTL+                                 | 0.87              | 1        | 1.1               |      |   |
| $V_I$     | Input voltage                        | A port            | 0        | 3.3               | 3.6  | V |
|           | B port                               | 0                 | $V_{TT}$ | 3.6               |      |   |
| $V_{IH}$  | HIGH-level input voltage             | A port            | 2        |                   |      | V |
|           | B port                               | $V_{REF} + 50$ mV |          |                   |      |   |
| $V_{IL}$  | LOW-level input voltage              | A port            |          | 0.8               |      | V |
|           | B port                               |                   |          | $V_{REF} - 50$ mV |      |   |
| $I_{OH}$  | HIGH-level output current            | A port            |          | –16               | mA   |   |
| $I_{OL}$  | LOW-level output current             | A port            |          | 16                | mA   |   |
|           | B port                               |                   |          | 15                |      |   |
| $T_A$     | Operating free-air temperature range | –40               |          | 85                | °C   |   |



**electrical characteristics over recommended operating conditions**

| PARAMETER          |                          | TEST CONDITIONS  | -40°C TO +85°C        |      |     | UNIT |
|--------------------|--------------------------|--|-----------------------|------|-----|------|
|                    |                          |  | MIN                   | TYP† | MAX |      |
| V <sub>OH</sub> ‡  | A port                   | V <sub>CC</sub> = 3 V to 3.6 V, I <sub>OH</sub> = -100 µA                            | V <sub>CC</sub> - 0.2 |      |     | V    |
|                    |                          | V <sub>CC</sub> = 3 V, I <sub>OH</sub> = -16 mA                                      | 2.1                   |      |     |      |
| V <sub>OL</sub> ‡  | A port                   | V <sub>CC</sub> = 3 V, I <sub>OL</sub> = 16 mA                                       | 0.8                   |      |     | V    |
|                    | B port                   | V <sub>CC</sub> = 3 V, I <sub>OL</sub> = 15 mA                                       | 0.4                   |      |     |      |
| I <sub>I</sub>     | A port                   | V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = V <sub>CC</sub>                            | ±1                    |      |     | µA   |
|                    |                          | V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = 0 V  | ±1                    |      |     |      |
|                    | B port                   | V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = V <sub>TT</sub> or GND                     | ±1                    |      |     |      |
| I <sub>CC</sub>    | A or B port              | V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 | 12                    |      |     | mA   |
| ΔI <sub>CC</sub> § | A port or control inputs | V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = V <sub>CC</sub> - 0.6 V                    | 500                   |      |     | µA   |
| C <sub>IO</sub>    | A port                   | V <sub>O</sub> = 3 V or 0  | 5                     |      |     | pF   |
|                    | B port                   | V <sub>O</sub> = V <sub>TT</sub> or 0  | 4                     |      |     |      |

† All typical values are measured at V<sub>CC</sub> = 3.3 V and T<sub>A</sub> = 25°C.

‡ The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

§ This is the increase in supply current for each input that is at the specified LVTTTL voltage, rather than V<sub>CC</sub> or GND.

**switching characteristics over recommended operating free-air temperature range**

| PARAMETER          |                 | WAVEFORM | GTL-  |      |     | GTL   |      |     | GTL+  |      |     | UNIT |
|--------------------|-----------------|----------|---|------|-----|---|------|-----|---|------|-----|------|
|                    |                 |          | V <sub>CC</sub> = 3.3 V ± 0.3 V<br>V <sub>REF</sub> = 0.6 V |      |     | V <sub>CC</sub> = 3.3 V ± 0.3 V<br>V <sub>REF</sub> = 0.8 V |      |     | V <sub>CC</sub> = 3.3 V ± 0.3 V<br>V <sub>REF</sub> = 1 V |      |     |      |
|                    |                 |          | MIN   | TYP† | MAX | MIN   | TYP† | MAX | MIN   | TYP† | MAX |      |
| t <sub>PLH</sub>   | An to Bn        | 1        | 2   | 4    | 8   | 2   | 4    | 8   | 2   | 4    | 8   | ns   |
| t <sub>PHL</sub>   |                 |          | 2   | 5.5  | 10  | 2   | 5.5  | 10  | 2   | 5.5  | 10  |      |
| t <sub>PLH</sub>   | Bn to An        | 2        | 2   | 5.5  | 10  | 2   | 5.5  | 10  | 2   | 5.5  | 10  | ns   |
| t <sub>PHL</sub>   |                 |          | 2   | 5.5  | 10  | 2   | 5.5  | 10  | 2   | 5.5  | 10  |      |
| t <sub>PLH</sub>   | 9BI to 10BOn    | 3        | 2   | 6    | 11  | 2   | 6    | 11  | 2   | 6    | 11  | ns   |
| t <sub>PHL</sub>   |                 |          | 2   | 6    | 11  | 2   | 6    | 11  | 2   | 6    | 11  |      |
| t <sub>PLH</sub>   | 11BI to 11BO    | 3        | 2   | 8    | 13  | 2   | 8    | 13  | 2   | 8    | 13  | ns   |
| t <sub>PHL</sub> ¶ |                 |          | 2   | 14   | 21  | 2   | 14   | 21  | 2   | 14   | 21  |      |
| t <sub>PLH</sub>   | Bn to Bn        | 3        | 4   | 7    | 11  | 4   | 7    | 11  | 4   | 7    | 11  | ns   |
| t <sub>PHL</sub>   |                 |          | 120   | 205  | 350 | 120   | 205  | 350 | 120   | 205  | 350 |      |
| t <sub>PLH</sub>   | ENn to An       | 4        | 1   | 3    | 7   | 1   | 3    | 7   | 1   | 3    | 7   | ns   |
| t <sub>PHL</sub>   |                 |          | 1   | 3    | 7   | 1   | 3    | 7   | 1   | 3    | 7   |      |
| t <sub>PLZ</sub>   | Bn to An (I/O)  | 5        | 2   | 5    | 10  | 2   | 5    | 10  | 2   | 5    | 10  | ns   |
| t <sub>PZL</sub>   |                 |          | 2   | 5    | 10  | 2   | 5    | 10  | 2   | 5    | 10  |      |
| t <sub>PLZ</sub>   | EN2 to An (I/O) | 6        | 1   | 3    | 7   | 1   | 3    | 7   | 1   | 3    | 7   | ns   |
| t <sub>PZL</sub>   |                 |          | 1   | 3    | 7   | 1   | 3    | 7   | 1   | 3    | 7   |      |

† All typical values are measured at V<sub>CC</sub> = 3.3 V and T<sub>A</sub> = 25°C.

¶ Includes ~7.6-ns RC rise time of test-load pullup on 11-A, 1.5-kΩ pullup, and 21-pF load on 11 A has approximately 23-ns RC rise time.

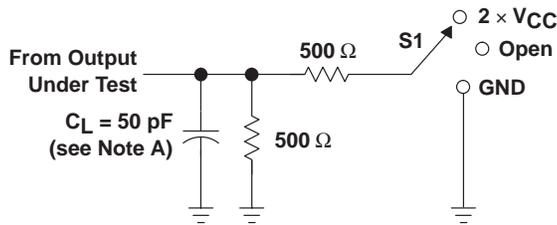
# SN74GTL2007

## 12-BIT GTL-/GTL/GTL+ TO LVTTTL TRANSLATOR

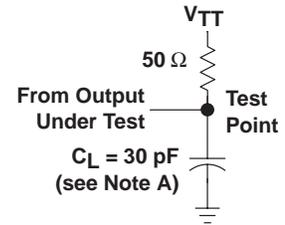
SCLS609 – MARCH 2005

### PARAMETER MEASUREMENT INFORMATION

$V_{TT} = 1.2\text{ V}$ ,  $V_{REF} = 0.8\text{ V}$  FOR GTL AND  $V_{TT} = 1.5\text{ V}$ ,  $V_{REF} = 1\text{ V}$  FOR GTL+

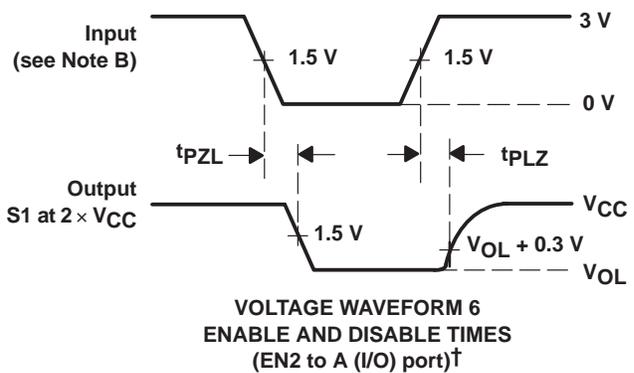
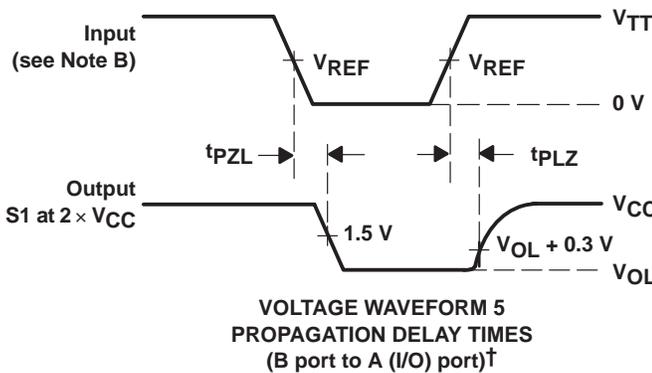
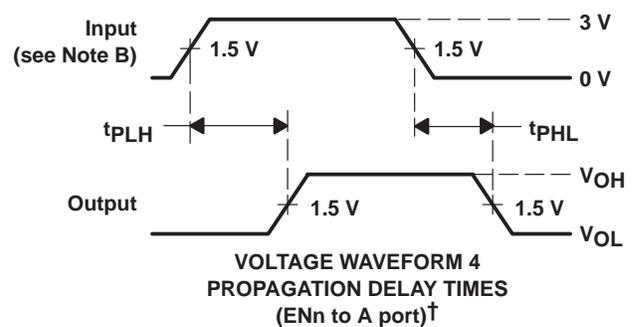
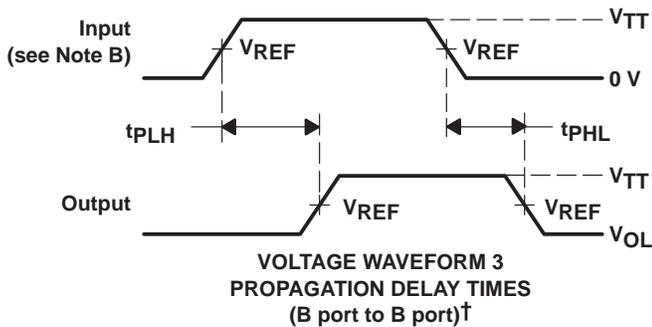
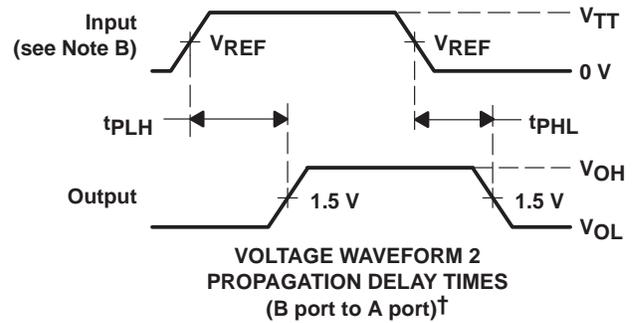
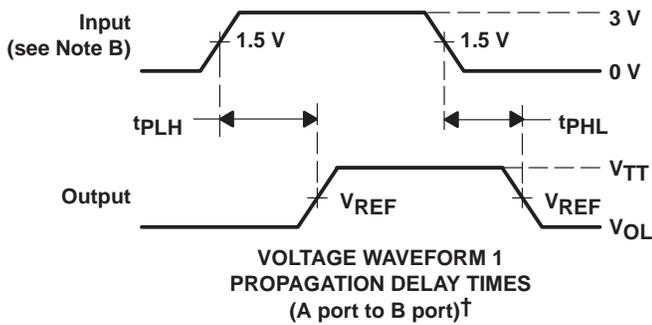


| TEST              | S1                |
|-------------------|-------------------|
| $t_{PLH}/t_{PHL}$ | Open              |
| $t_{PLZ}/t_{PZL}$ | $2 \times V_{CC}$ |



LOAD CIRCUIT FOR A OUTPUTS

LOAD CIRCUIT FOR B OUTPUTS



<sup>†</sup> All control inputs are LVTTTL levels.

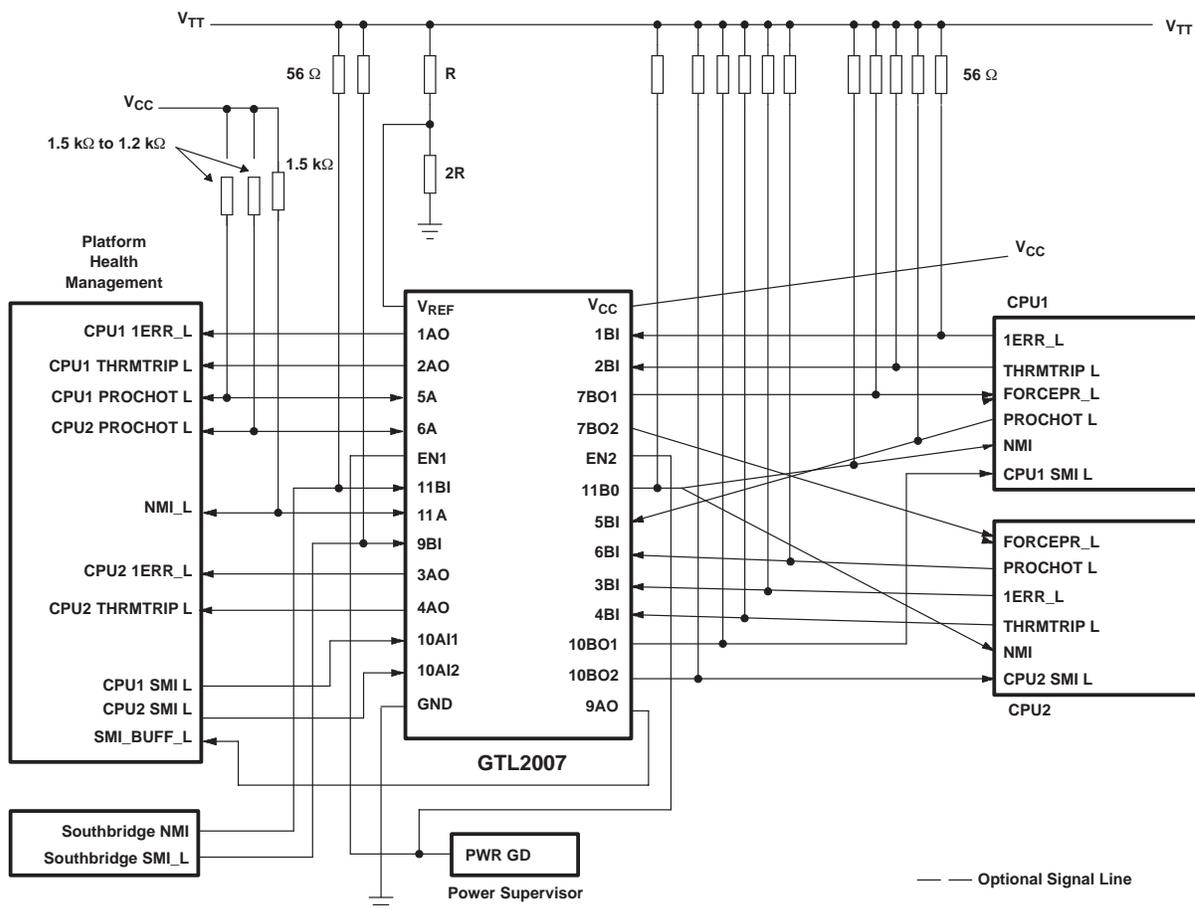
NOTES: A.  $C_L$  includes probe and jig capacitance.

B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .

C. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

**APPLICATION INFORMATION**



**Frequently Asked Questions**

**Question 1:** On the GTL2007 LVTTL input, specifically 10AI1 and 10AI2, when the GTL2007 is powered down, these inputs may be pulled up to 3.3 V, and we want to ensure that there is no leakage path to the power rail under this condition. Are the LVTTL inputs high impedance when the device is powered down, and will there be any leakage?

**Answer 1:** When the device is powered down, the LVTTL inputs are in a high-impedance state and do not leak to  $V_{DD}$  if they are pulled high while the device is powered down.

**Question 2:** Do all the LVTTL inputs have the same powered-down characteristic?

**Answer 2:** Yes

**Question 3:** What is the condition of the other GTL I/O and LVTTL output pins when the device is powered down?

**Answer 3:** The open-drain outputs, both GTL and LVTTL, do not leak to the power supply if they are pulled high while the device is powered down. The GTL inputs also do not leak to the power supply under the same conditions. The LVTTL totem-pole outputs, however, are not open-drain type outputs, and there is no current flow on these pins if they are pulled high when  $V_{DD}$  is at ground.

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN74GTL2007PW    | ACTIVE                | TSSOP        | PW              | 28   | 50          | Pb-Free (RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM           |
| SN74GTL2007PWR   | ACTIVE                | TSSOP        | PW              | 28   | 2000        | Pb-Free (RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

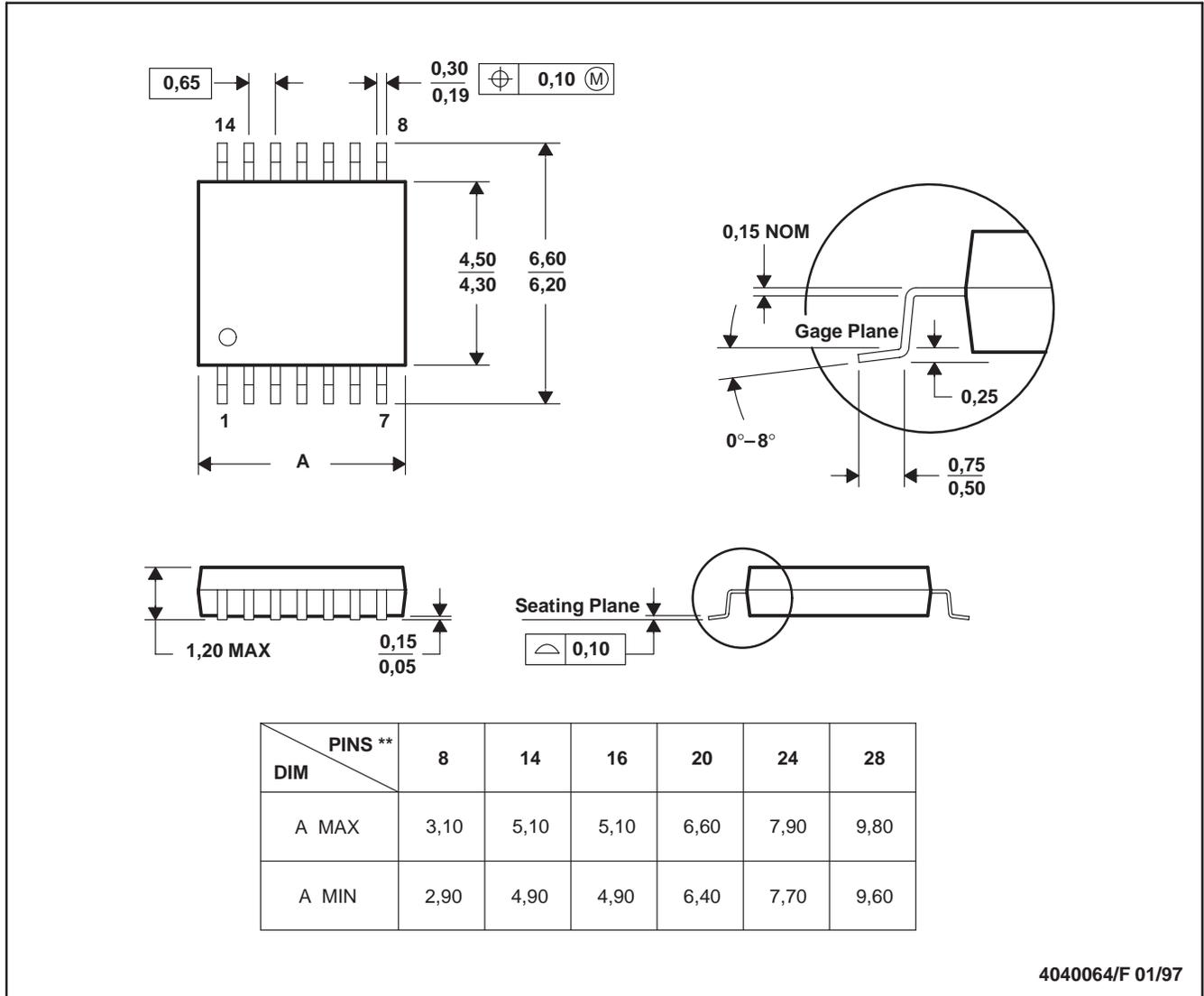
**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

| <b>Products</b>  |  | <b>Applications</b> |  |
|------------------|--|---------------------|--|
| Amplifiers       | <a href="http://amplifier.ti.com">amplifier.ti.com</a>             | Audio               | <a href="http://www.ti.com/audio">www.ti.com/audio</a>                   |
| Data Converters  | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>     | Automotive          | <a href="http://www.ti.com/automotive">www.ti.com/automotive</a>         |
| DSP              | <a href="http://dsp.ti.com">dsp.ti.com</a>                         | Broadband           | <a href="http://www.ti.com/broadband">www.ti.com/broadband</a>           |
| Interface        | <a href="http://interface.ti.com">interface.ti.com</a>             | Digital Control     | <a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a> |
| Logic            | <a href="http://logic.ti.com">logic.ti.com</a>                     | Military            | <a href="http://www.ti.com/military">www.ti.com/military</a>             |
| Power Mgmt       | <a href="http://power.ti.com">power.ti.com</a>                     | Optical Networking  | <a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a> |
| Microcontrollers | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a> | Security            | <a href="http://www.ti.com/security">www.ti.com/security</a>             |
|                  |  | Telephony           | <a href="http://www.ti.com/telephony">www.ti.com/telephony</a>           |
|                  |  | Video & Imaging     | <a href="http://www.ti.com/video">www.ti.com/video</a>                   |
|                  |  | Wireless            | <a href="http://www.ti.com/wireless">www.ti.com/wireless</a>             |

Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265